

S-82C1F Series

Rev.1.3 00

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BATTERY PROTECTION IC FOR 1-CELL PACK

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The S-82C1F Series is a protection IC for lithium-ion / lithium polymer rechargeable batteries and includes high-accuracy voltage detection circuits and delay circuits. It is suitable for protecting 1-cell lithium-ion / lithium polymer rechargeable battery packs from overcharge, overdischarge, and overcurrent.

By using an external overcurrent detection resistor, the S-82C1F Series realizes high-accuracy overcurrent protection with less effect from temperature change.

Features

| High-accuracy voltage detection circuit | | |
|--|--|--|
| Overcharge detection voltage | 3.500 V to 4.600 V (5 mV step) | Accuracy ±20 mV |
| Overcharge release voltage | 3.100 V to 4.600 V*1 | Accuracy ±50 mV |
| Overdischarge detection voltage | 2.000 V to 3.000 V (10 mV step) | Accuracy ±50 mV |
| Overdischarge release voltage | 2.000 V to 3.400 V*2 | Accuracy ±100 mV |
| Discharge overcurrent detection voltage 1 | 0.010 V to 0.100 V (1 mV step) | Accuracy ±3 mV |
| Discharge overcurrent detection voltage 2 | 0.030 V to 0.200 V (1 mV step) | Accuracy ±5 mV |
| Load short-circuiting detection voltage | 0.050 V to 0.500 V (5 mV step) | Accuracy ±20 mV |
| Charge overcurrent detection voltage | –0.100 V to –0.010 V (1 mV step) | Accuracy ±3 mV |
| • Detection delay times are generated only by an in | nternal circuit (external capacitors are | e unnecessary). |
| 0 V battery charge: | Enabled, inhibited | |
| Power-down function: | Available, unavailable | |
| • Release condition of discharge overcurrent status: | Load disconnection, charger connection | ction |
| Release voltage of discharge overcurrent status: | Discharge overcurrent detection volta | ge 1 (Vdiov1), |
| | discharge overcurrent release voltage | $e(V_{RIOV}) = V_{DD} \times 0.8 (typ.)$ |
| High-withstand voltage: | VM pin and CO pin: Absolute maxin | num rating 28 V |
| Wide operation temperature range: | Ta = -40°C to +85°C | |
| Low current consumption | | |
| During operation: | 2.0 μA typ., 4.0 μA max. (Ta = +25° | C) |
| During power-down: | 50 nA max. (Ta = +25°C) | |
| During overdischarge: | 1.0 μA max. (Ta = +25°C) | |
| Lead-free, Sn 100%, halogen-free^{*3} | | |
| During operation: During power-down: During overdischarge: | 50 nA max. (Ta = +25°C) | C) |

- *1. Overcharge release voltage = Overcharge detection voltage Overcharge hysteresis voltage (Overcharge hysteresis voltage can be selected as 0 V or from a range of 0.1 V to 0.4 V in 50 mV step.)
- *2. Overdischarge release voltage = Overdischarge detection voltage + Overdischarge hysteresis voltage (Overdischarge hysteresis voltage can be selected as 0 V or from a range of 0.1 V to 0.7 V in 100 mV step.)
- *3. Refer to "■ Product Name Structure" for details.

Applications

- Lithium-ion rechargeable battery pack
- Lithium polymer rechargeable battery pack

Packages

- SNT-6A
- DFN-6(1414)A

BATTERY PROTECTION IC FOR 1-CELL PACK S-82C1F Series

Block Diagram

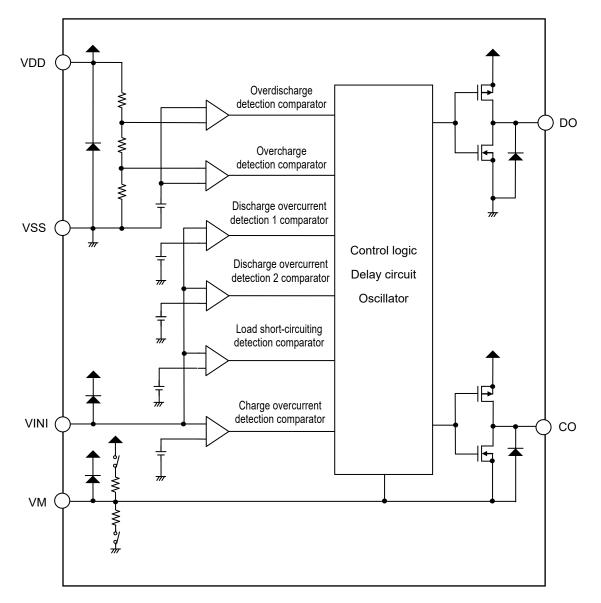
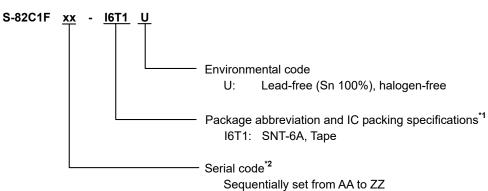


Figure 1

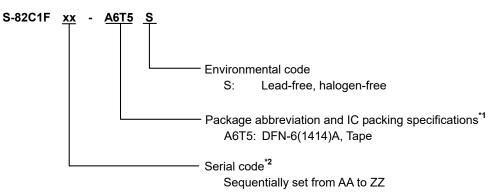
Product Name Structure

- 1. Product name
 - 1.1 SNT-6A



- ***1.** Refer to the tape drawing.
- *2. Refer to "3. Product name list".

1.2 DFN-6(1414)A



- *1. Refer to the tape drawing.
- *2. Refer to "3. Product name list".

2. Packages

Table 1 Package Drawing Codes

| Package Name | Dimension | Таре | Reel | Land |
|--------------|--------------|--------------|--------------|--------------|
| SNT-6A | PG006-A-P-SD | PG006-A-C-SD | PG006-A-R-SD | PG006-A-L-SD |
| DFN-6(1414)A | PV006-A-P-SD | PV006-A-C-SD | PV006-A-R-SD | PV006-A-L-SD |

3. Product name list

3.1 SNT-6A

| | Table 2 (1 / 2) | | | | | | | | | | | | |
|-----------------|---|---|---|---|--|--|--|---|--|--|--|--|--|
| Product Name | Overcharge Detection Voltage [Vcu] | Overcharge Release Voltage [VcL] | Overdischarge Detection Voltage [V _{DL}] | Overdischarge Release Voltage [V _{DU}] | Discharge Overcurrent Detection Voltage 1 [VDIOV1] | Discharge Overcurrent Detection Voltage 2 [VDIOV2] | Load Short- circuiting Detection Voltage [V _{SHORT}] | Charge Overcurrent Detection Voltage [V _{CIOV}] | | | | | |
| S-82C1FAA-I6T1U | 4.470 V | 4.270 V | 2.500 V | 2.900 V | 0.0210 V | - | 0.070 V | -0.024 V | | | | | |
| S-82C1FAB-I6T1U | 4.470 V | 4.270 V | 2.500 V | 2.900 V | 0.0240 V | - | 0.075 V | –0.024 V | | | | | |
| S-82C1FAC-I6T1U | 4.475 V | 4.275 V | 2.500 V | 2.900 V | 0.0210 V | - | 0.080 V | –0.021 V | | | | | |
| S-82C1FAD-I6T1U | 4.520 V | 4.320 V | 2.100 V | 2.300 V | 0.0210 V | - | 0.100 V | -0.024 V | | | | | |
| S-82C1FAG-I6T1U | 4.520 V | 4.320 V | 2.300 V | 2.700 V | 0.0225 V | _ | 0.110 V | –0.027 V | | | | | |

Table 2 (2 / 2)

| Product Name | Delay Time Combination ^{*1} | 0 V Battery Charge*2 | Power-down Function ^{*3} | Release Condition of Discharge Overcurrent Status*4 | Release Voltage of Discharge Overcurrent Status* ⁵ |
|-----------------|---|----------------------|--------------------------------------|---|--|
| S-82C1FAA-I6T1U | (1) | Enabled | Unavailable | Load disconnection | Vriov |
| S-82C1FAB-I6T1U | (1) | Enabled | Unavailable | Load disconnection | Vriov |
| S-82C1FAC-I6T1U | (2) | Inhibited | Unavailable | Load disconnection | Vriov |
| S-82C1FAD-I6T1U | (3) | Inhibited | Unavailable | Load disconnection | Vriov |
| S-82C1FAG-I6T1U | (5) | Enabled | Unavailable | Load disconnection | Vriov |

*1. Refer to **Table 4** about the details of the delay time combinations.

*2. 0 V battery charge: Enabled, inhibited

*3. Power-down function: Available, unavailable

*4. Release condition of discharge overcurrent status: Load disconnection, charger connection

*5. Release voltage of discharge overcurrent status: V_{DIOV1} , $V_{RIOV} = V_{DD} \times 0.8$ (typ.)

Remark Please contact our sales representatives for products other than the above.

3.2 DFN-6(1414)A

| | Table 3 (1 / 2) | | | | | | | | | | | |
|-----------------|---|---|---|---|--|--|--|--|--|--|--|--|
| Product Name | Overcharge Detection Voltage [Vcu] | Overcharge Release Voltage [VcL] | Overdischarge Detection Voltage [V _{DL}] | Overdischarge Release Voltage [V _{DU}] | Discharge Overcurrent Detection Voltage 1 [VDIOV1] | Discharge Overcurrent Detection Voltage 2 [VDIOV2] | Load Short- circuiting Detection Voltage [V _{SHORT}] | Charge Overcurrent Detection Voltage [Vciov] | | | | |
| S-82C1FAE-A6T5S | 4.475 V | 4.275 V | 2.500 V | 2.800 V | 0.0400 V | - | 0.150 V | –0.030 V | | | | |
| S-82C1FAF-A6T5S | 4.475 V | 4.275 V | 2.500 V | 2.900 V | 0.0225 V | - | 0.080 V | –0.021 V | | | | |
| S-82C1FAH-A6T5S | 4.500 V | 4.300 V | 2.600 V | 3.000 V | 0.0400 V | - | 0.180 V | –0.030 V | | | | |

Table 3 (2 / 2)

| Product Name | Delay Time Combination ^{*1} | 0 V Battery Charge*2 | Power-down Function ^{*3} | Release Condition of Discharge Overcurrent Status*4 | Release Voltage of Discharge Overcurrent Status* ⁵ |
|-----------------|---|----------------------|--------------------------------------|---|--|
| S-82C1FAE-A6T5S | (4) | Inhibited | Unavailable | Load disconnection | Vriov |
| S-82C1FAF-A6T5S | (4) | Inhibited | Unavailable | Load disconnection | Vriov |
| S-82C1FAH-A6T5S | (4) | Inhibited | Unavailable | Load disconnection | Vriov |

***1.** Refer to **Table 4** about the details of the delay time combinations.

*2. 0 V battery charge: Enabled, inhibited

*3. Power-down function: Available, unavailable

*4. Release condition of discharge overcurrent status: Load disconnection, charger connection

*5. Release voltage of discharge overcurrent status: V_{DIOV1} , $V_{RIOV} = V_{DD} \times 0.8$ (typ.)

Remark Please contact our sales representatives for products other than the above.

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| | | | Table 4 | | | |
|---------------------------|---|--|--|--|---|--|
| Delay Time Combination | Overcharge Detection Delay Time [t _{Cu}] | Overdischarge Detection Delay Time [t _{DL}] | Discharge Overcurrent Detection Delay Time 1 [t _{DIOV1}] | Discharge Overcurrent Detection Delay Time 2 [t _{DIOV2}] | Load Short- circuiting Detection Delay Time [t _{SHORT}] | Charge Overcurrent Detection Delay Time [t _{CIOV}] |
| (1) | 1.0 s | 64 ms | 16 ms | _ | 280 μs | 16 ms |
| (2) | 1.0 s | 64 ms | 256 ms | _ | 280 μs | 16 ms |
| (3) | 1.0 s | 64 ms | 512 ms | — | 280 μs | 16 ms |
| (4) | 1.0 s | 32 ms | 16 ms | — | 280 μs | 16 ms |
| (5) | 1.0 s | 32 ms | 64 ms | _ | 280 μs | 16 ms |

Remark The delay times can be changed within the range listed in **Table 5**. For details, please contact our sales representatives.

| Table 5 | | | | | | | | | | |
|--|--------------------|--------|--------|----------|---------|-------|--------|-------------------------------|--|--|
| Delay Time | Symbol | | | Selectio | n Range | | | Remark | | |
| Overcharge detection delay time | t _{cu} | 256 ms | 512 ms | 1.0 s | Ι | - | - | Select a value from the left. | | |
| Overdischarge detection delay time | toL | 32 ms | 64 ms | 128 ms | 256 ms | Ι | - | Select a value from the left. | | |
| Discharge overcurrent | + | 4 ms | 8 ms | 16 ms | 32 ms | 64 ms | 128 ms | Select a value from the | | |
| detection delay time 1 | t _{DIOV1} | 256 ms | 512 ms | 1.0 s | 2.0 s | 4.0 s | 8.0 s | left. | | |
| Discharge overcurrent detection delay time 2 | t _{DIOV2} | 4 ms | 8 ms | 16 ms | 32 ms | 64 ms | 128 ms | Select a value from the left. | | |
| Load short-circuiting detection delay time | t _{SHORT} | 280 μs | 530 μs | _ | _ | _ | - | Select a value from the left. | | |
| Charge overcurrent detection delay time | t _{CIOV} | 4 ms | 8 ms | 16 ms | 32 ms | 64 ms | 128 ms | Select a value from the left. | | |

Rev.1.3_00

Pin Configurations

1. SNT-6A

Top view 1 3 1 6 5 4

Figure 2

| | Table 6 | | | | | | | | | | |
|---------|----------------------------|--|--|--|--|--|--|--|--|--|--|
| Pin No. | Pin No. Symbol Description | | | | | | | | | | |
| 1 | VM | Input pin for external negative voltage | | | | | | | | | |
| 2 | со | Connection pin of charge control FET gate (CMOS output) | | | | | | | | | |
| 3 | DO | Connection pin of discharge control FET gate (CMOS output) | | | | | | | | | |
| 4 | VSS | Input pin for negative power supply | | | | | | | | | |
| 5 | VDD | Input pin for positive power supply | | | | | | | | | |
| 6 | VINI | Overcurrent detection pin | | | | | | | | | |

2. DFN-6(1414)A

| Top view | | Table 7 | | | | | | | |
|-------------|---------|---------|--|--|--|--|--|--|--|
| 1 💿 6 | Pin No. | Symbol | Description | | | | | | |
| 3 4 | 1 | VSS | Input pin for negative power supply | | | | | | |
| 0 1 | 2 | VDD | Input pin for positive power supply | | | | | | |
| Bottom view | 3 | VINI | Overcurrent detection pin | | | | | | |
| | 4 | VM | Input pin for external negative voltage | | | | | | |
| | 5 | со | Connection pin of charge control FET gate (CMOS output) | | | | | | |
| \ *1 | 6 | DO | Connection pin of discharge control FET gate (CMOS output) | | | | | | |

Figure 3

*1. Connect the heat sink of backside at shadowed area to the board, and set electric potential open or V_{DD}. However, do not use it as the function of electrode.

Absolute Maximum Ratings

Table 8

| (Ta = +25°C unless otherwise spe | | | | | | | | |
|---|-------------------|-------------|--|------|--|--|--|--|
| Item | Symbol | Applied Pin | Absolute Maximum Rating | Unit | | | | |
| Input voltage between VDD pin and VSS pin | V _{DS} | VDD | $V_{SS} - 0.3$ to $V_{SS} + 6$ | V | | | | |
| VINI pin input voltage | V _{VINI} | VINI | $V_{DD} - 6$ to $V_{DD} + 0.3$ | V | | | | |
| VM pin input voltage | Vvm | VM | $V_{\text{DD}}-28$ to $V_{\text{DD}}+0.3$ | V | | | | |
| DO pin output voltage | Vdo | DO | $V_{\text{SS}}-0.3$ to $V_{\text{DD}}+0.3$ | V | | | | |
| CO pin output voltage | Vco | СО | $V_{\text{VM}}-0.3$ to $V_{\text{DD}}+0.3$ | V | | | | |
| Operation ambient temperature | Topr | _ | -40 to +85 | °C | | | | |
| Storage temperature | T _{stg} | _ | –55 to +125 | Ο° | | | | |

Caution The absolute maximum ratings are rated values exceeding which the product could suffer physical damage. These values must therefore not be exceeded under any conditions.

Thermal Resistance Value

| | | Table 9 | | | | | |
|--|-----------------|--------------|---------|------|------|------|------|
| Item | Symbol | Cond | dition | Min. | Тур. | Max. | Unit |
| | | | Board A | - | 224 | - | °C/W |
| | | | Board B | - | 176 | - | °C/W |
| | | SNT-6A | Board C | _ | _ | - | °C/W |
| | | | Board D | _ | _ | - | °C/W |
| Junction-to-ambient thermal resistance*1 | θ _{JA} | | Board E | - | - | - | °C/W |
| | UJA | | Board A | - | 315 | - | °C/W |
| | | | Board B | - | 276 | - | °C/W |
| | | DFN-6(1414)A | Board C | - | 1 | - | °C/W |
| | | | Board D | - | 1 | - | °C/W |
| | | | Board E | - | - | - | °C/W |

*1. Test environment: compliance with JEDEC STANDARD JESD51-2A

Remark Refer to "■ Power Dissipation" and "Test Board" for details.

Electrical Characteristics

1. Ta = +25°C

| 1. Ta = +25°C | | Table 10 | (| (Ta = +25°(| C unless otherw | ise sp | ecified) |
|--|---------------------|--|----------------------------|----------------------------|-----------------------------|--------|-----------------|
| Item | Symbol | Condition | Min. | Тур. | Max. | Unit | Test Circuit |
| Detection Voltage | | | | - | | | |
| Overcharge detection voltage | V _{CU} | - | $V_{CU}-0.020$ | V _{CU} | $V_{CU} + 0.020$ | V | 1 |
| Overeberge release veltage | V _{CL} | V _{CL} ≠ V _{CU} | $V_{\text{CL}}-0.050$ | V _{CL} | $V_{CL} + 0.050$ | V | 1 |
| Overcharge release voltage | VCL | $V_{CL} = V_{CU}$ | $V_{CL}-0.025$ | V _{CL} | $V_{CL} + 0.020$ | V | 1 |
| Overdischarge detection voltage | V _{DL} | _ | $V_{DL} - 0.050$ | V _{DL} | $V_{DL} + 0.050$ | V | 2 |
| Overdischarge release voltage | V _{DU} | V _{DL} ≠ V _{DU} | V _{DU} - 0.100 | V _{DU} | V _{DU} + 0.100 | V | 2 |
| | | $V_{DL} = V_{DU}$ | V _{DU} - 0.050 | V _{DU} | V _{DU} + 0.050 | V | 2 |
| Discharge overcurrent detection voltage 1 | V _{DIOV1} | - | V _{DIOV1} – 0.003 | V _{DIOV1} | V _{DIOV1} + 0.003 | V | 2 |
| Discharge overcurrent detection voltage 2 | V _{DIOV2} | - | V _{DIOV2} - 0.005 | V _{DIOV2} | V _{DIOV2} + 0.005 | V | 2 |
| Load short-circuiting detection voltage | VSHORT | - | $V_{\text{SHORT}} - 0.020$ | VSHORT | $V_{SHORT} + 0.020$ | V | 2 |
| Load short-circuiting detection voltage 2 | V _{SHORT2} | - | V _{DD} – 1.2 | $V_{\text{DD}}-0.8$ | $V_{\text{DD}} - 0.5$ | V | 2 |
| Charge overcurrent detection voltage | Vciov | - | $V_{\text{CIOV}}-0.003$ | VCIOV | $V_{CIOV} + 0.003$ | V | 2 |
| Discharge overcurrent release voltage | VRIOV | V _{DD} = 3.4 V | $V_{DD} \times 0.77$ | $V_{\text{DD}} \times 0.8$ | $V_{\text{DD}} \times 0.83$ | V | 2 |
| 0 V Battery Charge | . | • | i | i | i | | |
| 0 V battery charge starting charger voltage | V _{0CHA} | 0 V battery charge enabled | 0.0 | 0.7 | 1.0 | V | 2 |
| 0 V battery charge inhibition battery voltage | Voinh | 0 V battery charge inhibited | 0.9 | 1.2 | 1.5 | V | 2 |
| Internal Resistance | • | | | n | | | |
| Resistance between VDD pin and VM pin | R _{VMD} | V_{DD} = 1.8 V, V_{VM} = 0 V | 500 | 1000 | 2000 | kΩ | 3 |
| Resistance between VM pin and VSS pin | R _{VMS} | V_{DD} = 3.4 V, V_{VM} = 1.0 V | 5 | 10 | 15 | kΩ | 3 |
| Input Voltage | r | | | r | | | |
| Operation voltage between VDD pin and VSS pin | V DSOP1 | _ | 1.5 | - | 6.0 | V | - |
| Operation voltage between VDD pin and VM pin | V _{DSOP2} | - | 1.5 | - | 28 | V | - |
| Input Current | | | | | | | |
| Current consumption during operation | I _{OPE} | V _{DD} = 3.4 V, V _{VM} = 0 V | _ | 2.0 | 4.0 | μA | 3 |
| Current consumption during power-down | I PDN | V _{DD} = V _{VM} = 1.5 V | _ | - | 0.05 | μΑ | 3 |
| Current consumption during overdischarge | IOPED | $V_{DD} = V_{VM} = 1.5 V$ | - | - | 1.0 | μA | 3 |
| Output Resistance | 1 | | 1 | 1 | 1 | 1 | |
| CO pin resistance "H" | RCOH | - | 5 | 10 | 20 | kΩ | 4 |
| CO pin resistance "L" | R _{COL} | - | 5 | 10 | 20 | kΩ | 4 |
| DO pin resistance "H" | Rdoh | - | 5 | 10 | 20 | kΩ | 4 |
| DO pin resistance "L" | R _{DOL} | - | 1 | 2 | 4 | kΩ | 4 |
| Delay Time | T | | | [| | 1 | · |
| Overcharge detection delay time | t _{CU} | - | $t_{CU} \times 0.7$ | t _{cu} | $t_{CU} \times 1.3$ | - | 5 |
| Overdischarge detection delay time | t _{DL} | - | $t_{DL} \times 0.7$ | t _{DL} | $t_{DL} \times 1.3$ | - | 5 |
| Discharge overcurrent detection delay time 1 | t _{DIOV1} | - | $t_{DIOV1} \times 0.75$ | t _{DIOV1} | $t_{DIOV1} \times 1.25$ | - | 5 |
| Discharge overcurrent detection delay time 2 | | - | $t_{DIOV2} \times 0.7$ | t _{DIOV2} | $t_{DIOV2} \times 1.3$ | - | 5 |
| Load short-circuiting detection delay time | t _{SHORT} | - | t _{SHORT} × 0.7 | t _{SHORT} | t _{SHORT} × 1.3 | - | 5 |
| Charge overcurrent detection delay time | tciov | - | $t_{CIOV} 	imes 0.7$ | tciov | $t_{CIOV} \times 1.3$ | — | 5 |

BATTERY PROTECTION IC FOR 1-CELL PACK S-82C1F Series

2. Ta = -20° C to $+60^{\circ}$ C^{*1}

| | | Table 11 | (Ta = −20°C | to +60°C*1 ر | unless otherwi | se sp | ecified) |
|---|---------------------|--|---------------------------------------|-----------------------|---------------------------------------|----------|-----------------|
| Item | Symbol | Condition | Min. | Тур. | Max. | Unit | Test Circuit |
| Detection Voltage | | | | | - | - | |
| Overcharge detection voltage | Vcu | - | $V_{CU}-0.025$ | V _{CU} | $V_{CU} + 0.025$ | V | 1 |
| Oversharge release veltage | V _{CL} | V _{CL} ≠ V _{CU} | $V_{\text{CL}}-0.065$ | V _{CL} | $V_{CL} + 0.057$ | V | 1 |
| Overcharge release voltage | VCL | V _{CL} = V _{CU} | $V_{\text{CL}}-0.030$ | V _{CL} | $V_{CL} + 0.025$ | V | 1 |
| Overdischarge detection voltage | V _{DL} | - | $V_{DL} - 0.060$ | V _{DL} | V _{DL} +0.055 | V | 2 |
| | \ <i>\</i> | V _{DL} ≠ V _{DU} | $V_{DU} - 0.110$ | V _{DU} | $V_{DU} + 0.105$ | V | 2 |
| Overdischarge release voltage | V _{DU} | V _{DL} = V _{DU} | V _{DU} - 0.060 | V _{DU} | $V_{DU} + 0.055$ | V | 2 |
| Discharge overcurrent detection voltage 1 | V _{DIOV1} | _ | V _{DIOV1} - 0.003 | V _{DIOV1} | $V_{DIOV1} + 0.003$ | V | 2 |
| Discharge overcurrent detection voltage 2 | V _{DIOV2} | _ | $V_{DIOV2} - 0.005$ | V _{DIOV2} | $V_{DIOV2} + 0.005$ | V | 2 |
| Load short-circuiting detection voltage | V _{SHORT} | _ | V _{SHORT} - 0.020 | VSHORT | V _{SHORT} +0.020 | V | 2 |
| Load short-circuiting detection voltage 2 | V _{SHORT2} | _ | V _{DD} – 1.4 | V _{DD} - 0.8 | $V_{DD} - 0.3$ | V | 2 |
| Charge overcurrent detection voltage | V _{CIOV} | _ | V _{CIOV} - 0.003 | V _{CIOV} | V _{CIOV} +0.003 | V | 2 |
| Discharge overcurrent release voltage | V _{RIOV} | V _{DD} = 3.4 V | VDD × 0.77 | $V_{DD} \times 0.80$ | | V | 2 |
| 0 V Battery Charge | 1.01 | | | | | | |
| 0 V battery charge starting charger voltage | V _{0CHA} | 0 V battery charge enabled | 0.0 | 0.7 | 1.5 | V | 2 |
| 0 V battery charge inhibition battery voltage | V _{0INH} | 0 V battery charge inhibited | 0.7 | 1.2 | 1.7 | V | 2 |
| Internal Resistance | | | | | | | |
| Resistance between VDD pin and VM pin | | V _{DD} = 1.8 V, V _{VM} = 0 V | 250 | 1000 | 3000 | kΩ | 3 |
| Resistance between VM pin and VSS pin | R _{VMS} | V_{DD} = 3.4 V, V_{VM} = 1.0 V | 3.5 | 10 | 20 | kΩ | 3 |
| Input Voltage | - | 1 | | | | [| 1 |
| Operation voltage between VDD pin and VSS pin | V _{DSOP1} | _ | 1.5 | - | 6.0 | V | - |
| Operation voltage between VDD pin and VM pin | V _{DSOP2} | _ | 1.5 | - | 28 | V | - |
| Input Current | | | Γ | | 5.0 | • | |
| Current consumption during operation | I _{OPE} | $V_{DD} = 3.4 \text{ V}, V_{VM} = 0 \text{ V}$ | _ | 2.0 | 5.0 | μA | 3 |
| Current consumption during power-down Current consumption during overdischarge | I _{PDN} | $V_{DD} = V_{VM} = 1.5 V$ $V_{DD} = V_{VM} = 1.5 V$ | - | _ | 0.1 | μA μA | 3 3 |
| Output Resistance | I _{OPED} | VDD - VVM - 1.5 V | _ | - | 1.5 | μA | 3 |
| CO pin resistance "H" | R _{COH} | _ | 2.5 | 10 | 30 | kΩ | 4 |
| CO pin resistance "L" | R _{COL} | _ | 2.5 | 10 | 30 | kΩ | 4 |
| DO pin resistance "H" | RDOH | _ | 2.5 | 10 | 30 | kΩ | 4 |
| DO pin resistance "L" | R _{DOL} | _ | 0.5 | 2 | 6 | kΩ | 4 |
| Delay Time | | · · · · · · · · · · · · · · · · · · · | · · · · · · · · · · · · · · · · · · · | | · · · · · · · · · · · · · · · · · · · | | |
| Overcharge detection delay time | t _{CU} | - | $t_{CU} 	imes 0.6$ | t _{cu} | $t_{CU} 	imes 1.4$ | _ | 5 |
| Overdischarge detection delay time | t _{DL} | - | $t_{DL} 	imes 0.6$ | t _{DL} | $t_{\text{DL}} \times 1.4$ | - | 5 |
| Discharge overcurrent detection delay time 1 | t _{DIOV1} | - | $t_{\text{DIOV1}} 	imes 0.65$ | t _{DIOV1} | $t_{\text{DIOV1}} 	imes 1.35$ | - | 5 |
| Discharge overcurrent detection delay time 2 | t _{DIOV2} | _ | $t_{DIOV2} \times 0.6$ | t _{DIOV2} | $t_{DIOV2} \times 1.4$ | - | 5 |
| | t _{SHORT} | - | t _{SHORT} × 0.6 | t _{SHORT} | $t_{SHORT} \times 1.4$ | - | 5 |
| Charge overcurrent detection delay time | t _{CIOV} | - | $t_{CIOV} 	imes 0.6$ | tciov | $t_{CIOV} \times 1.4$ | — | 5 |

*1. Since products are not screened at high and low temperature, the specification for this temperature range is guaranteed by design, not tested in production.

BATTERY PROTECTION IC FOR 1-CELL PACK S-82C1F Series

3. Ta = -40° C to $+85^{\circ}$ C^{*1}

| | | Table 12 | (Ta = –40°C | to +85°C*1 | unless otherw | ise sp | ecified) |
|--|--------------------------------------|--|------------------------------|------------------------------|------------------------------|--------|-----------------|
| ltem | Symbol | Condition | Min. | Тур. | Max. | Unit | Test Circuit |
| Detection Voltage | • | | | | | | |
| Overcharge detection voltage | V _{CU} | - | $V_{CU}-0.045$ | V _{CU} | $V_{CU} + 0.030$ | V | 1 |
| Overcharge release voltage | V _{CL} | V _{CL} ≠ V _{CU} | $V_{\text{CL}}-0.080$ | V _{CL} | V _{CL} +0.060 | V | 1 |
| overeinarge release voltage | VCL | $V_{CL} = V_{CU}$ | $V_{\text{CL}}-0.050$ | V _{CL} | $V_{CL} + 0.030$ | V | 1 |
| Overdischarge detection voltage | V _{DL} | - | $V_{\text{DL}}-0.080$ | V _{DL} | $V_{DL} + 0.060$ | V | 2 |
| Overdischarge release voltage | V _{DU} | V _{DL} ≠ V _{DU} | $V_{\text{DU}}-0.130$ | V _{DU} | $V_{DU} + 0.110$ | V | 2 |
| Overdischarge release voltage | V DU | $V_{DL} = V_{DU}$ | $V_{\text{DU}}-0.080$ | V _{DU} | $V_{DU} + 0.060$ | V | 2 |
| Discharge overcurrent detection voltage 1 | V _{DIOV1} | - | $V_{\text{DIOV1}}-0.003$ | V _{DIOV1} | $V_{\text{DIOV1}}\!+\!0.003$ | V | 2 |
| Discharge overcurrent detection voltage 2 | V _{DIOV2} | - | $V_{\text{DIOV2}}-0.005$ | V _{DIOV2} | $V_{\text{DIOV2}}\!+\!0.005$ | V | 2 |
| Load short-circuiting detection voltage | VSHORT | - | $V_{\text{SHORT}}-0.020$ | VSHORT | $V_{\text{SHORT}} + 0.020$ | V | 2 |
| Load short-circuiting detection voltage 2 | V _{SHORT2} | - | $V_{DD}-1.4$ | $V_{\text{DD}}-0.8$ | $V_{\text{DD}}-0.3$ | V | 2 |
| Charge overcurrent detection voltage | Vciov | _ | $V_{\text{CIOV}} - 0.003$ | V _{CIOV} | V _{CIOV} +0.003 | V | 2 |
| Discharge overcurrent release voltage | V _{RIOV} | V _{DD} = 3.4 V | $V_{\text{DD}} \times 0.77$ | $V_{\text{DD}}\!\times\!0.8$ | $V_{\text{DD}} \times 0.83$ | V | 2 |
| 0 V Battery Charge | | | | | | | |
| 0 V battery charge starting charger voltage | V _{0CHA} | 0 V battery charge enabled | 0.0 | 0.7 | 1.5 | V | 2 |
| 0 V battery charge inhibition battery voltage | Voinh | 0 V battery charge inhibited | 0.7 | 1.2 | 1.7 | V | 2 |
| Internal Resistance | | | | | | | |
| Resistance between VDD pin and VM pin | R _{VMD} | V _{DD} = 1.8 V, V _{VM} = 0 V | 250 | 1000 | 3000 | kΩ | 3 |
| Resistance between VM pin and VSS pin | R _{VMS} | V_{DD} = 3.4 V, V_{VM} = 1.0 V | 3.5 | 10 | 20 | kΩ | 3 |
| Input Voltage | 1 | Γ | | | I | | |
| Operation voltage between VDD pin and VSS pin | V _{DSOP1} | _ | 1.5 | - | 6.0 | V | - |
| Operation voltage between VDD pin and VM pin | V _{DSOP2} | _ | 1.5 | _ | 28 | V | - |
| Input Current | i. | L | | | 1 | i . | |
| Current consumption during operation | I _{OPE} | $V_{DD} = 3.4 \text{ V}, V_{VM} = 0 \text{ V}$ | - | 2.0 | 5.0 | μA | 3 |
| Current consumption during power-down | IPDN | $V_{DD} = V_{VM} = 1.5 V$ | _ | _ | 0.1 | μA | 3 |
| Current consumption during overdischarge | IOPED | $V_{DD} = V_{VM} = 1.5 V$ | - | _ | 1.5 | μA | 3 |
| Output Resistance CO pin resistance "H" | Page | - | 2.5 | 10 | 30 | kΩ | 4 |
| CO pin resistance "L" | R _{COH} R _{COL} | | 2.5 | 10 | 30 | kΩ | 4 |
| DO pin resistance "H" | RDOH | | 2.5 | 10 | 30 | kΩ | 4 |
| DO pin resistance "L" | RDOL | _ | 0.5 | 2 | 6 | kΩ | 4 |
| Delay Time | -501 | 1 | | | | | |
| Overcharge detection delay time | t _{CU} | - | $t_{CU} \times 0.4$ | t _{cu} | $t_{CU} \times 1.6$ | - | 5 |
| Overdischarge detection delay time | t _{DL} | - | $t_{DL} \times 0.4$ | t _{DL} | t _{DL} × 1.6 | - | 5 |
| Discharge overcurrent detection delay time 1 | t _{DIOV1} | _ | $t_{\text{DIOV1}} 	imes 0.4$ | t _{DIOV1} | $t_{\text{DIOV1}} 	imes 1.6$ | - | 5 |
| Discharge overcurrent detection delay time 2 | t _{DIOV2} | - | $t_{\text{DIOV2}} 	imes 0.4$ | t _{DIOV2} | $t_{\text{DIOV2}} 	imes 1.6$ | _ | 5 |
| Load short-circuiting detection delay time | t _{SHORT} | - | $t_{\text{SHOR}} 	imes 0.4$ | t _{SHORT} | $t_{\text{SHORT}} 	imes 1.6$ | - | 5 |
| Charge overcurrent detection delay time | t _{CIOV} | - | $t_{CIOV} 	imes 0.4$ | t _{CIOV} | $t_{CIOV} 	imes 1.6$ | - | 5 |

*1. Since products are not screened at high and low temperature, the specification for this temperature range is guaranteed by design, not tested in production.

Test Circuits

Caution Unless otherwise specified, the output voltage levels "H" and "L" at CO pin (V_{CO}) and DO pin (V_{DO}) are judged by the threshold voltage (1.0 V) of the N-channel FET. Judge the CO pin level with respect to V_{VM} and the DO pin level with respect to V_{SS} .

1. Overcharge detection voltage, overcharge release voltage (Test circuit 1)

Overcharge detection voltage (V_{CU}) is defined as the voltage V1 at which V_{CO} goes from "H" to "L" when the voltage V1 is gradually increased from the starting condition of V1 = 3.4 V. Overcharge release voltage (V_{CL}) is defined as the voltage V1 at which V_{CO} goes from "L" to "H" when the voltage V1 is then gradually decreased. Overcharge hysteresis voltage (V_{HC}) is defined as the difference between V_{CU} and V_{CL} .

2. Overdischarge detection voltage, overdischarge release voltage (Test circuit 2)

Overdischarge detection voltage (V_{DL}) is defined as the voltage V1 at which V_{DO} goes from "H" to "L" when the voltage V1 is gradually decreased from the starting conditions of V1 = 3.4 V, V2 = V5 = 0 V. Overdischarge release voltage (V_{DU}) is defined as the voltage V1 at which V_{DO} goes from "L" to "H" when setting V2 = 0.01 V, V5 = 0 V and when the voltage V1 is then gradually increased. Overdischarge hysteresis voltage (V_{HD}) is defined as the difference between V_{DU} and V_{DL} .

3. Discharge overcurrent detection voltage 1, discharge overcurrent release voltage (Test circuit 2)

3. 1 Release voltage of discharge overcurrent status "VDIOV1"

Discharge overcurrent detection voltage 1 (V_{DIOV1}) is defined as the voltage V5 whose delay time for changing V_{DO} from "H" to "L" is discharge overcurrent detection delay time 1 (t_{DIOV1}) when the voltage V5 is increased from the starting conditions of V1 = 3.4 V, V2 = 1.4 V, V5 = 0 V. V_{DO} goes from "L" to "H" when setting V2 = 3.4 V, V5 = 0 V and when the voltage V2 is then gradually decreased to V_{DIOV1} typ. or lower.

3. 2 Release voltage of discharge overcurrent status "VRIOV"

 V_{DIOV1} is defined as the voltage V5 whose delay time for changing V_{DO} from "H" to "L" is t_{DIOV1} when the voltage V5 is increased from the starting conditions of V1 = 3.4 V, V2 = 1.4 V, V5 = 0 V. Discharge overcurrent release voltage (V_{RIOV}) is defined as the voltage V2 at which V_{DO} goes from "L" to "H" when setting V2 = 3.4 V, V5 = 0 V and when the voltage V2 is then gradually decreased.

4. Discharge overcurrent detection voltage 2 (Test circuit 2)

Discharge overcurrent detection voltage 2 (V_{DIOV2}) is defined as the voltage V5 whose delay time for changing V_{DO} from "H" to "L" is discharge overcurrent detection delay time 2 (t_{DIOV2}) when the voltage V5 is increased after setting V1 = 3.4 V, V2 = 1.4 V, V5 = 0 V.

5. Load short-circuiting detection voltage (Test circuit 2)

Load short-circuiting detection voltage (V_{SHORT}) is defined as the voltage V5 whose delay time for changing V_{DO} from "H" to "L" is load short-circuiting detection delay time (t_{SHORT}) when the voltage V5 is increased from the starting conditions of V1 = 3.4 V, V2 = 1.4 V, V5 = 0 V.

6. Load short-circuiting detection voltage 2 (Test circuit 2)

Load short-circuiting detection voltage 2 (V_{SHORT2}) is defined as the voltage V2 whose delay time for changing V_{DO} from "H" to "L" is t_{SHORT} when the voltage V2 is increased from the starting conditions of V1 = 3.4 V, V2 = V5 = 0 V.

7. Charge overcurrent detection voltage (Test circuit 2)

Charge overcurrent detection voltage (V_{CIOV}) is defined as the voltage V5 whose delay time for changing V_{CO} from "H" to "L" is charge overcurrent detection delay time (t_{CIOV}) when the voltage V5 is decreased from the starting conditions of V1 = 3.4 V, V2 = V5 = 0 V.

8. Current consumption during operation (Test circuit 3)

The current consumption during operation (I_{OPE}) is the current that flows through the VDD pin (I_{DD}) under the set conditions of V1 = 3.4 V and V2 = V5 = 0 V.

9. Current consumption during power-down, current consumption during overdischarge (Test circuit 3)

9.1 With power-down function

The current consumption during power-down (I_{PDN}) is I_{DD} under the set conditions of V1 = V2 = 1.5 V, V5 = 0 V.

9.2 Without power-down function

The current consumption during overdischarge (I_{OPED}) is I_{DD} under the set conditions of V1 = V2 = 1.5 V, V5 = 0 V.

10. Resistance between VDD pin and VM pin (Test circuit 3)

 R_{VMD} is the resistance between VDD pin and VM pin under the set conditions of V1 = 1.8 V, V2 = V5 = 0 V.

11. Resistance between VM pin and VSS pin (Release condition of discharge overcurrent status "load disconnection") (Test circuit 3)

 R_{VMS} is the resistance between VM pin and VSS pin when the voltage V5 is decreased to 0 V from the starting conditions of V1 = 3.4 V, V2 = V5 = 1.0 V.

12. CO pin resistance "H" (Test circuit 4)

The CO pin resistance "H" (R_{COH}) is the resistance between VDD pin and CO pin under the set conditions of V1 = 3.4 V, V2 = V5 = 0 V, V3 = 3.0 V.

13. CO pin resistance "L" (Test circuit 4)

The CO pin resistance "L" (R_{COL}) is the resistance between VM pin and CO pin under the set conditions of V1 = 4.7 V, V2 = V5 = 0 V, V3 = 0.4 V.

14. DO pin resistance "H" (Test circuit 4)

The DO pin resistance "H" (R_{DOH}) is the resistance between VDD pin and DO pin under the set conditions of V1 = 3.4 V, V2 = V5 = 0 V, V4 = 3.0 V.

15. DO pin resistance "L" (Test circuit 4)

The DO pin resistance "L" (R_{DOL}) is the resistance between VSS pin and DO pin under the set conditions of V1 = 1.8 V, V2 = V5 = 0 V, V4 = 0.4 V.

16 Overcharge detection delay time (Test circuit 5)

The overcharge detection delay time (t_{CU}) is the time needed for V_{CO} to go to "L" just after the voltage V1 increases and exceeds V_{CU} under the set conditions of V1 = 3.4 V, V2 = V5 = 0 V.

17. Overdischarge detection delay time (Test circuit 5)

The overdischarge detection delay time (t_{DL}) is the time needed for V_{DO} to go to "L" after the voltage V1 decreases and falls below V_{DL} under the set conditions of V1 = 3.4 V, V2 = V5 = 0 V.

18. Discharge overcurrent detection delay time 1 (Test circuit 5)

The discharge overcurrent detection delay time 1 (t_{DIOV1}) is the time needed for V_{DO} to go to "L" after the voltage V5 increases and exceeds V_{DIOV1} under the set conditions of V1 = 3.4 V, V2 = 1.4 V, V5 = 0 V.

19. Discharge overcurrent detection delay time 2 (Test circuit 5)

Increase the voltage V5 after setting V1 = 3.4 V, V2 = 1.4 V, V5 = 0 V. The discharge overcurrent detection delay time 2 (t_{DIOV2}) is the time period from when the voltage V5 exceeds V_{DIOV2} until V_{DO} goes to "L".

20. Load short-circuiting detection delay time (Test circuit 5)

The load short-circuiting detection delay time (t_{SHORT}) is the time needed for V_{DO} to go to "L" after the voltage V5 increases and exceeds V_{SHORT} under the set conditions of V1 = 3.4 V, V2 = 1.4 V, V5 = 0 V.

21. Charge overcurrent detection delay time (Test circuit 5)

The charge overcurrent detection delay time (t_{CIOV}) is the time needed for V_{CO} to go to "L" after the voltage V5 decreases and falls below V_{CIOV} under the set conditions of V1 = 3.4 V, V2 = V5 = 0 V.

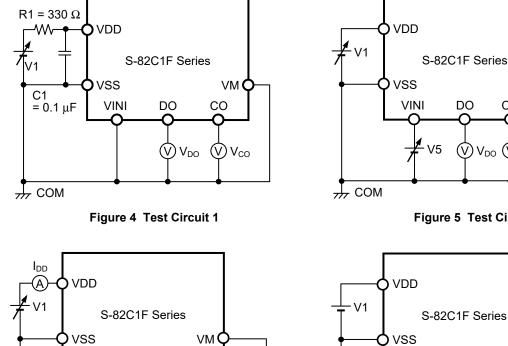
22. 0 V battery charge starting charger voltage (0 V battery charge enabled) (Test circuit 2)

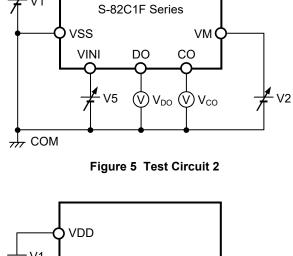
The 0 V battery charge starting charger voltage (V_{0CHA}) is defined as the absolute value of voltage V2 at which V_{CO} goes to "H" ($V_{CO} = V_{DD}$) when the voltage V2 is gradually decreased from the starting condition of V1 = V2 = V5 = 0 V.

23. 0 V battery charge inhibition battery voltage (0 V battery charge inhibited) (Test circuit 2)

The 0 V battery charge inhibition battery voltage (V_{0INH}) is defined as the voltage V1 at which V_{CO} goes to "L" (V_{CO} = V_{VM}) when the voltage V1 is gradually decreased, after setting V1 = 1.8 V, V2 = -2.0 V, V5 = 0 V.

BATTERY PROTECTION IC FOR 1-CELL PACK S-82C1F Series





DO

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VINI

V5

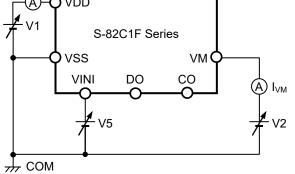


Figure 6 Test Circuit 3

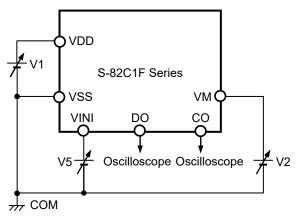




Figure 7 Test Circuit 4

V4

VMĊ

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(A) Ico

V3

- V2

Operation

Remark Refer to "■ Battery Protection IC Connection Example".

1. Normal status

The S-82C1F Series monitors the voltage of the battery connected between VDD pin and VSS pin, the voltage between VINI pin and VSS pin to control charging and discharging. When the battery voltage is in the range from overdischarge detection voltage (V_{DL}) to overcharge detection voltage (V_{CU}), and the VINI pin voltage is in the range from charge overcurrent detection voltage (V_{CIOV}) to discharge overcurrent detection voltage 1 (V_{DIOV1}), the S-82C1F Series turns both the charge and discharge control FETs on. This condition is called the normal status, and in this condition charging and discharging can be carried out freely.

The resistance between VDD pin and VM pin (R_{VMD}), and the resistance between VM pin and VSS pin (R_{VMS}) are not connected in the normal status.

Caution After the battery is connected, discharging may not be carried out. In this case, the S-82C1F Series returns to the normal status by connecting a charger.

2. Overcharge status

2. 1 VcL ≠ Vcu (Product in which overcharge release voltage differs from overcharge detection voltage)

When the battery voltage becomes higher than V_{CU} during charging in the normal status and the condition continues for the overcharge detection delay time (t_{CU}) or longer, the S-82C1F Series turns the charge control FET off to stop charging. This condition is called the overcharge status.

The overcharge status is released in the following two cases.

- (1) In the case that the VM pin voltage is lower than 0.35 V typ., the S-82C1F Series releases the overcharge status when the battery voltage falls below overcharge release voltage (V_{CL}).
- (2) In the case that the VM pin voltage is equal to or higher than 0.35 V typ., the S-82C1F Series releases the overcharge status when the battery voltage falls below V_{CU} .

When the discharge is started by connecting a load after the overcharge detection, the VM pin voltage rises by the V_f voltage of the parasitic diode than the VSS pin voltage, because the discharge current flows through the parasitic diode in the charge control FET. If this VM pin voltage is equal to or higher than 0.35 V typ., the S-82C1F Series releases the overcharge status when the battery voltage is equal to or lower than V_{CU} .

Caution If the battery is charged to a voltage higher than V_{cu} and the battery voltage does not fall below V_{cu} even when a heavy load is connected, discharge overcurrent detection and load short-circuiting detection do not function until the battery voltage falls below V_{cu} . Since an actual battery has an internal impedance of tens of m Ω , the battery voltage drops immediately after a heavy load that causes overcurrent is connected, and discharge overcurrent detection and load short-circuiting detection function.

2. 2 $V_{CL} = V_{CU}$ (Product in which overcharge release voltage is the same as overcharge detection voltage)

When the battery voltage becomes higher than V_{CU} during charging in the normal status and the condition continues for the overcharge detection delay time (t_{CU}) or longer, the S-82C1F Series turns the charge control FET off to stop charging. This condition is called the overcharge status.

In the case that the VM pin voltage is equal to or higher than 0.35 V typ. and the battery voltage falls below V_{CU} , the S-82C1F Series releases the overcharge status.

When the discharge is started by connecting a load after the overcharge detection, the VM pin voltage rises by the V_f voltage of the parasitic diode than the VSS pin voltage, because the discharge current flows through the parasitic diode in the charge control FET. If this VM pin voltage is equal to or higher than 0.35 V typ., the S-82C1F Series releases the overcharge status when the battery voltage is equal to or lower than V_{CU} .

- Caution 1. If the battery is charged to a voltage higher than V_{cu} and the battery voltage does not fall below V_{cu} even when a heavy load is connected, discharge overcurrent detection and load short-circuiting detection do not function until the battery voltage falls below V_{cu} . Since an actual battery has an internal impedance of tens of m Ω , the battery voltage drops immediately after a heavy load that causes overcurrent is connected, and discharge overcurrent detection and load short-circuiting detection function.
 - 2. When a charger is connected after overcharge detection, the overcharge status is not released even if the battery voltage is below V_{CL} . The overcharge status is released when the discharge current flows and the VM pin voltage goes over 0.35 V typ. by removing the charger.

3. Overdischarge status

When the battery voltage falls below V_{DL} during discharging in the normal status and the condition continues for the overdischarge detection delay time (t_{DL}) or longer, the S-82C1F Series turns the discharge control FET off to stop discharging. This condition is called the overdischarge status.

Under the overdischarge status, VDD pin and VM pin are shorted by R_{VMD} in the S-82C1F Series. The VM pin voltage is pulled up by R_{VMD}.

When connecting a charger in the overdischarge status, the battery voltage reaches V_{DL} or higher and the S-82C1F Series releases the overdischarge status if the VM pin voltage falls below 0 V typ.

The battery voltage reaches the overdischarge release voltage (V_{DU}) or higher and the S-82C1F Series releases the overdischarge status if the VM pin voltage does not fall below 0 V typ.

R_{VMS} is not connected in the overdischarge status.

3.1 With power-down function

Under the overdischarge status, when voltage difference between VDD pin and VM pin is 0.8 V typ. or lower, the power-down function works and the current consumption is reduced to the current consumption during power-down (I_{PDN}). By connecting a battery charger, the power-down function is released when the VM pin voltage is 0.7 V typ. or lower.

- When a battery is not connected to a charger and the VM pin voltage ≥ 0.7 V typ., the S-82C1F Series maintains the overdischarge status even when the battery voltage reaches V_{DU} or higher.
- When a battery is connected to a charger and 0.7 V typ. > the VM pin voltage > 0 V typ., the battery voltage reaches V_{DU} or higher and the S-82C1F Series releases the overdischarge status.
- When a battery is connected to a charger and 0 V typ. ≥ the VM pin voltage, the battery voltage reaches V_{DL} or higher and the S-82C1F Series releases the overdischarge status.

3. 2 Without power-down function

Under the overdischarge status, the power-down function does not work even when voltage difference between VDD pin and VM pin is 0.8 V typ. or lower.

- When a battery is not connected to a charger and the VM pin voltage ≥ 0.7 V typ., the battery voltage reaches V_{DU} or higher and the S-82C1F Series releases the overdischarge status.
- When a battery is connected to a charger and 0.7 V typ. > the VM pin voltage > 0 V typ., the battery voltage reaches V_{DU} or higher and the S-82C1F Series releases the overdischarge status.
- When a battery is connected to a charger and 0 V typ. ≥ the VM pin voltage, the battery voltage reaches V_{DL} or higher and the S-82C1F Series releases the overdischarge status.

4. Discharge overcurrent status (discharge overcurrent 1, discharge overcurrent 2, load shortcircuiting, load short-circuiting 2)

4.1 Discharge overcurrent 1, discharge overcurrent 2, load short-circuiting

When a battery in the normal status is in the status where the VINI pin voltage is equal to or higher than V_{DIOV1} because the discharge current is equal to or higher than the specified value and the status lasts for the discharge overcurrent detection delay time 1 (t_{DIOV1}) or longer, the discharge control FET is turned off and discharging is stopped. This condition is called the discharge overcurrent status.

4. 1. 1 Release condition of discharge overcurrent status "load disconnection" and release voltage of discharge overcurrent status "V_{DIOV1}"

Under the discharge overcurrent status, VM pin and VSS pin are shorted by R_{VMS} in the S-82C1F Series. However, the VM pin voltage is the VDD pin voltage due to the load as long as the load is connected. When the load is disconnected, the VM pin returns to the VSS pin voltage. When the VM pin voltage returns to V_{DIOV1} or lower, the S-82C1F Series releases the discharge overcurrent status. R_{VMD} is not connected in the discharge overcurrent status.

4. 1. 2 Release condition of discharge overcurrent status "load disconnection" and release voltage of discharge overcurrent status "V_{RIOV}"

Under the discharge overcurrent status, VM pin and VSS pin are shorted by R_{VMS} in the S-82C1F Series. However, the VM pin voltage is the VDD pin voltage due to the load as long as the load is connected. When the load is disconnected, the VM pin returns to the VSS pin voltage. When the VM pin voltage returns to V_{RIOV} or lower, the S-82C1F Series releases the discharge overcurrent status. R_{VMD} is not connected in the discharge overcurrent status.

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4. 1. 3 Release condition of discharge overcurrent status "charger connection"

Under the discharge overcurrent status, VDD pin and VM pin are shorted by R_{VMD} in the S-82C1F Series. When a battery is connected to a charger and the VM pin voltage returns to V_{DIOV1} or lower, the S-82C1F Series releases the discharge overcurrent status.

 R_{VMS} is not connected in the discharge overcurrent status.

4.2 Load short-circuiting 2

When a battery in the normal status is in the status where a load causing discharge overcurrent is connected, and the VM pin voltage is equal to or higher than V_{SHORT2} and the status lasts for the load short-circuiting detection delay time (t_{SHORT}) or longer, the discharge control FET is turned off and discharging is stopped. The S-82C1F Series then becomes discharge overcurrent status.

The S-82C1F Series releases the discharge overcurrent status in the same way as in "4. 1 Discharge overcurrent 1, discharge overcurrent 2, load short-circuiting".

5. Charge overcurrent status

When a battery in the normal status is in the status where the VINI pin voltage is equal to or lower than V_{CIOV} because the charge current is equal to or higher than the specified value and the status lasts for the charge overcurrent detection delay time (t_{CIOV}) or longer, the charge control FET is turned off and charging is stopped. This condition is called the charge overcurrent status.

The S-82C1F Series releases the charge overcurrent status when the discharge current flows and the VM pin voltage is 0.35 V typ. or higher by removing the charger.

The charge overcurrent detection does not function in the overdischarge status.

6. 0 V battery charge enabled

This function is used to recharge a connected battery whose voltage is 0 V due to self-discharge. When the 0 V battery charge starting charger voltage (V_{0CHA}) or a higher voltage is applied between the EB+ and EB- pins by connecting a charger, the charge control FET gate is fixed to the VDD pin voltage.

When the voltage between the gate and source of the charge control FET becomes equal to or higher than the threshold voltage due to the charger voltage, the charge control FET is turned on to start charging. At this time, the discharge control FET is off and the charging current flows through the internal parasitic diode in the discharge control FET. When the battery voltage becomes equal to or higher than V_{DL} , the S-82C1F Series returns to the normal status.

- Caution 1. Some battery providers do not recommend charging for a completely self-discharged lithium-ion rechargeable battery. Please ask the battery provider to determine whether to enable or inhibit the 0 V battery charge.
 - 2. The 0 V battery charge has higher priority than the charge overcurrent detection function. Consequently, a product in which use of the 0 V battery charge is enabled charges a battery forcibly and the charge overcurrent cannot be detected when the battery voltage is lower than V_{DL}.

7. 0 V battery charge inhibited

This function inhibits charging when a battery that is internally short-circuited (0 V battery) is connected. When the battery voltage is the 0 V battery charge inhibition battery voltage (V_{0INH}) or lower, the charge control FET gate is fixed to the EB– pin voltage to inhibit charging. When the battery voltage is V_{0INH} or higher, charging can be performed.

Caution Some battery providers do not recommend charging for a completely self-discharged lithium-ion rechargeable battery. Please ask the battery provider to determine whether to enable or inhibit the 0 V battery charge.

8. Delay circuit

The detection delay times are determined by dividing a clock of approximately 4 kHz by the counter.

Remark t_{DIOV1}, t_{DIOV2} and t_{SHORT} start when V_{DIOV1} is detected. When V_{DIOV2} or V_{SHORT} is detected over t_{DIOV2} or t_{SHORT} after the detection of V_{DIOV1}, the S-82C1F Series turns the discharge control FET off within t_{DIOV2} or t_{SHORT} of each detection.

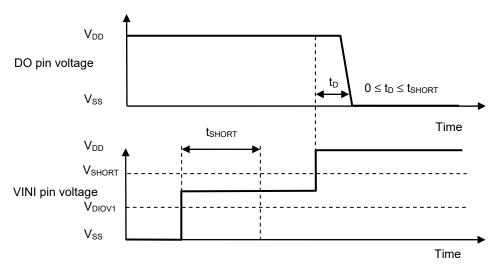
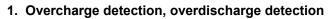
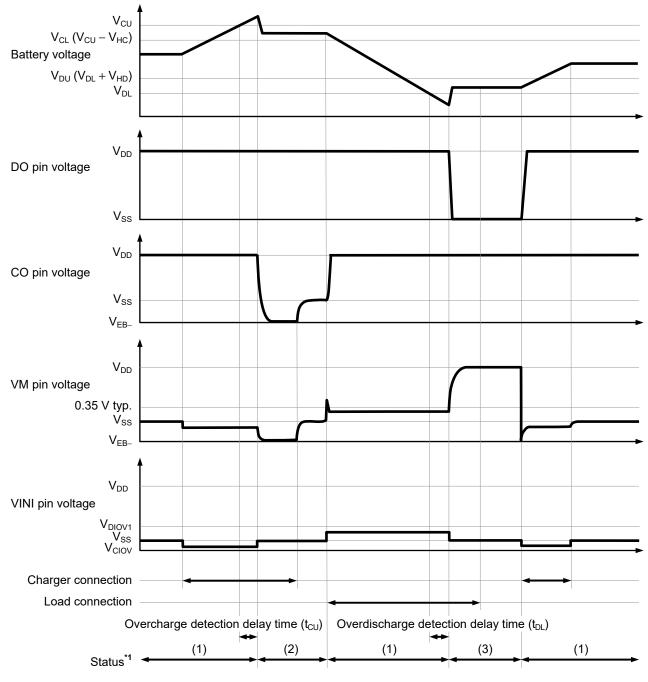


Figure 9

Timing Charts





*1. (1): Normal status

(2): Overcharge status

(3): Overdischarge status

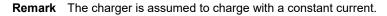
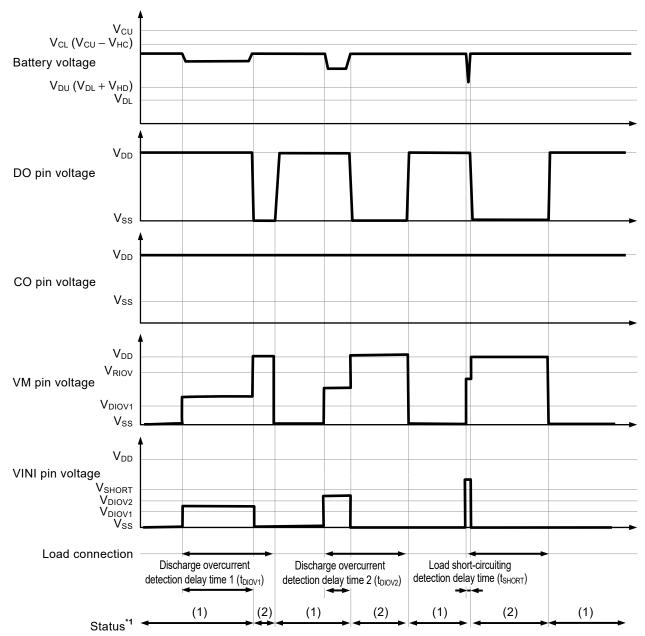


Figure 10

2. Discharge overcurrent detection



2.1 Release condition of discharge overcurrent status "load disconnection"

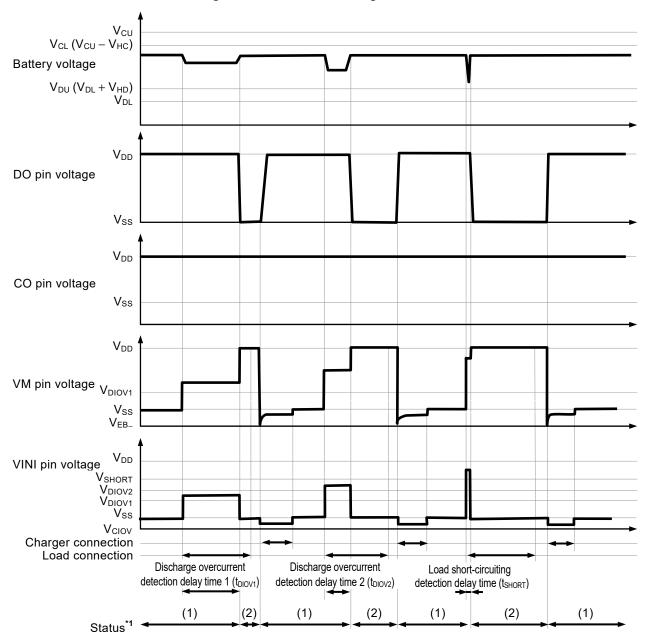
*1. (1): Normal status

(2): Discharge overcurrent status

Remark The charger is assumed to charge with a constant current.

Figure 11

Rev.1.3_00



2. 2 Release condition of discharge overcurrent status "charger connection"

*1. (1): Normal status

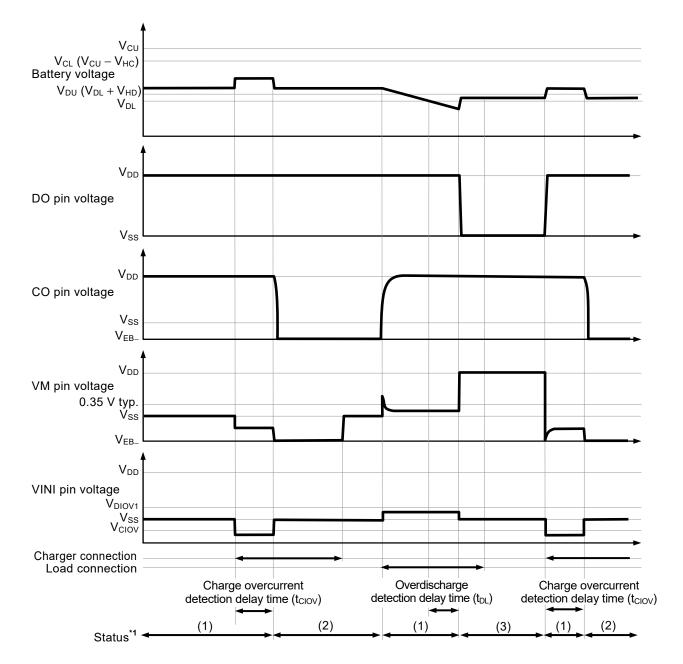
(2): Discharge overcurrent status

Remark The charger is assumed to charge with a constant current.

Figure 12

Rev.1.3_00

3. Charge overcurrent detection



*1. (1): Normal status

(2): Charge overcurrent status

(3): Overdischarge status

Remark The charger is assumed to charge with a constant current.

Figure 13

Battery Protection IC Connection Example

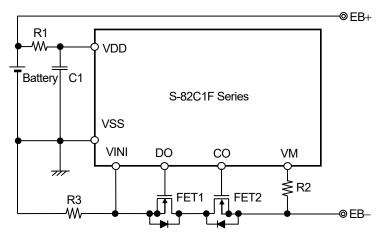


Figure 14

Table 13 Constants for External Components

| Symbol | Part | Purpose | Min. | Тур. | Max. | Remark |
|--------|----------------------|--|----------|-----------------|----------|--|
| FET1 | N-channel MOS FET | Discharge control | _ | - | _ | Threshold voltage ≤ Overdischarge detection voltage ^{*1} |
| FET2 | N-channel MOS FET | Charge control | _ | _ | _ | Threshold voltage ≤ Overdischarge detection voltage ^{*1} |
| R1 | Resistor | ESD protection, For power fluctuation | 270 Ω | 330 Ω | 1.2 kΩ*² | _ |
| C1 | Capacitor | For power fluctuation | 0.068 μF | 0.1 μF | 2.2 μF | _ |
| R2 | Resistor | ESD protection, Protection for reverse connection of a charger | 300 Ω | 470 Ω | 1.5 kΩ | _ |
| R3 | Resistor | Overcurrent detection | - | $5{ m m}\Omega$ | - | _ |

***1.** If a FET with a threshold voltage equal to or higher than the overdischarge detection voltage is used, discharging may be stopped before overdischarge is detected.

*2. Accuracy of overcharge detection voltage is guaranteed by R1 = 330 Ω . Connecting resistors with other values will worsen the accuracy.

Caution 1. The constants may be changed without notice.

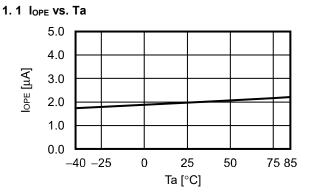
2. It has not been confirmed whether the operation is normal or not in circuits other than the connection example. In addition, the connection example and the constants do not guarantee proper operation. Perform thorough evaluation using the actual application to set the constants.

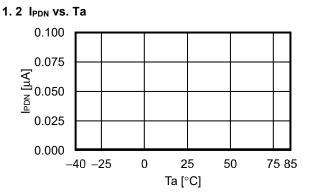
Precautions

- The application conditions for the input voltage, output voltage, and load current should not exceed the power dissipation.
- Do not apply an electrostatic discharge to this IC that exceeds the performance ratings of the built-in electrostatic protection circuit.
- ABLIC Inc. claims no responsibility for any and all disputes arising out of or in connection with any infringement by products including this IC of patents owned by a third party.

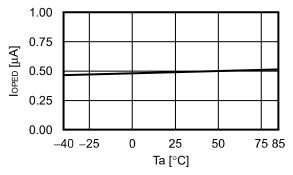
■ Characteristics (Typical Data)

1. Current consumption

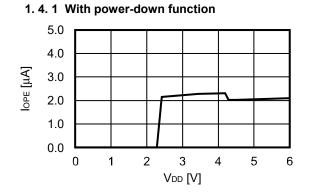




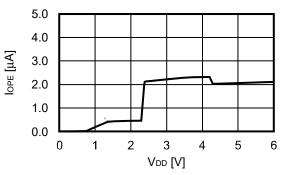
1.3 IOPED VS. Ta



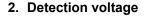
1.4 IOPE VS. VDD

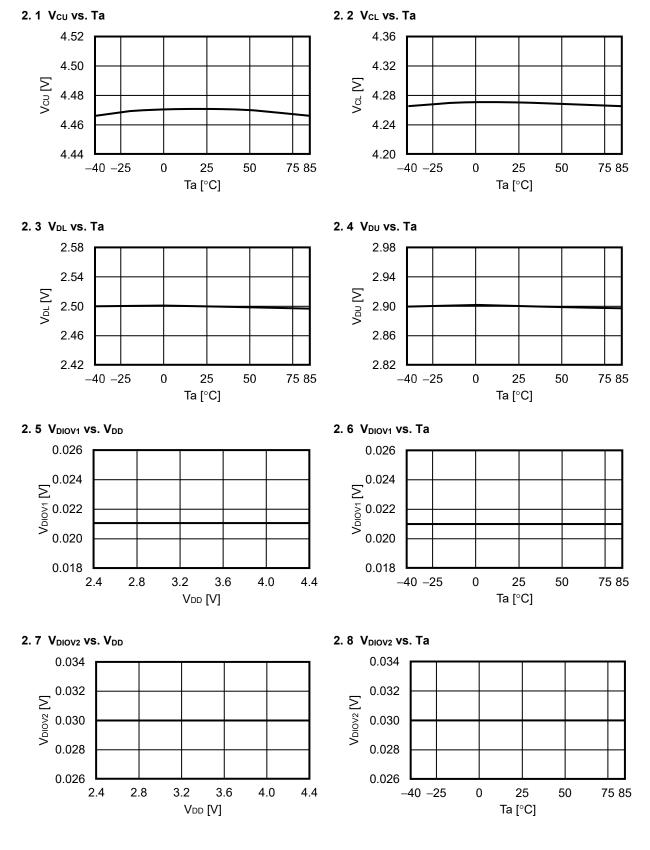


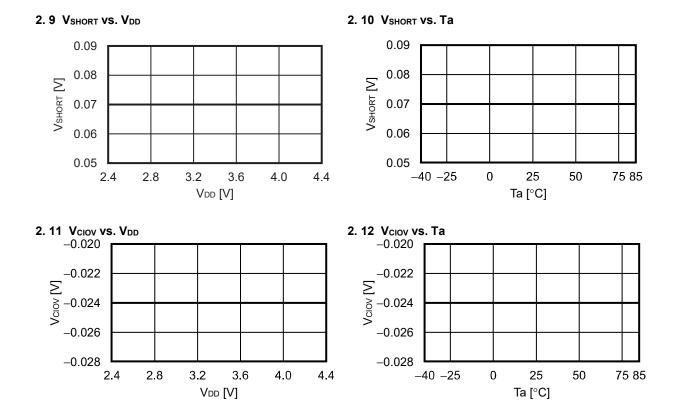
1. 4. 2 Without power-down function



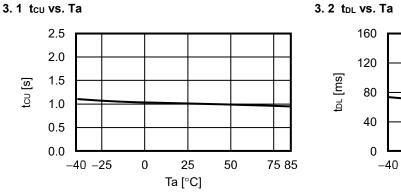
Rev.1.3_00

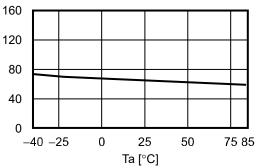


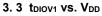


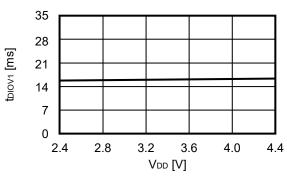


3. Delay time

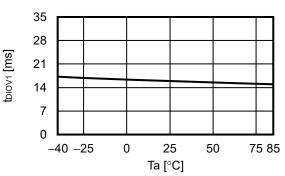


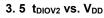


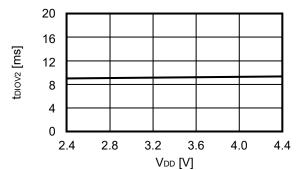




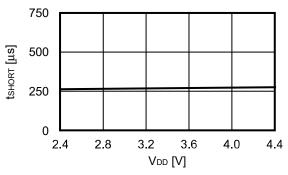
3. 4 t_{DIOV1} vs. Ta



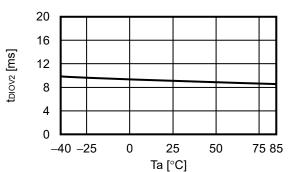




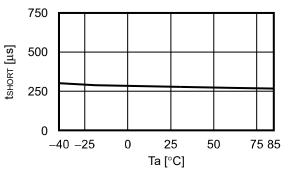


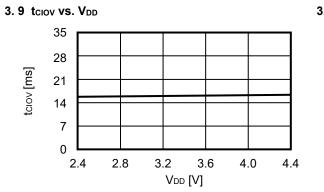


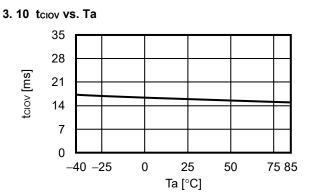
3.6 t_{DIOV2} vs. Ta





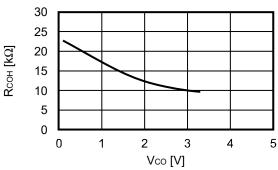




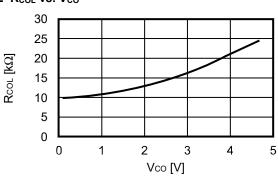


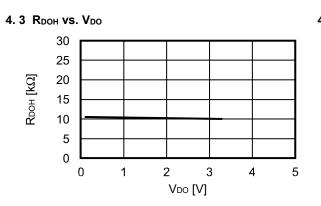
4. Output resistance



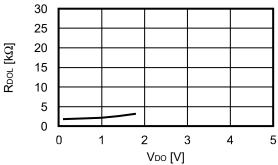


4. 2 R_{COL} vs. V_{CO}



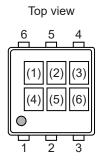


4.4 RDOL VS. VDO



Marking Specifications

1. SNT-6A

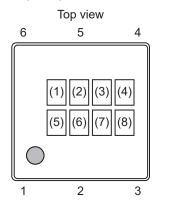


(1) to (3): (4) to (6): Product code (Refer to **Product name vs. Product code**) Lot number

Product name vs. Product code

| Dreduct Name | Pro | oduct Co | ode |
|-----------------|-----|----------|-----|
| Product Name | (1) | (2) | (3) |
| S-82C1FAA-I6T1U | 6 | S | А |
| S-82C1FAB-I6T1U | 6 | S | В |
| S-82C1FAC-I6T1U | 6 | S | С |
| S-82C1FAD-I6T1U | 6 | S | D |
| S-82C1FAG-I6T1U | 6 | S | G |

2. DFN-6(1414)A



(1) to (3): (4): (5) to (8): Product code (Refer to **Product name vs. Product code**) Product code (Fixed) Lot number

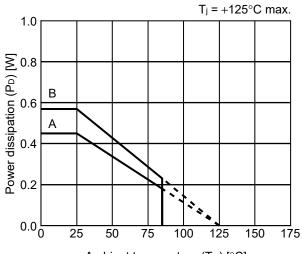
Product name vs. Product code

| Dreduct Norse | Product Code | | | | |
|-----------------|--------------|-----|-----|--|--|
| Product Name | (1) | (2) | (3) | | |
| S-82C1FAE-A6T5S | 6 | S | Е | | |
| S-82C1FAF-A6T5S | 6 | S | F | | |
| S-82C1FAH-A6T5S | 6 | S | Н | | |

Power Dissipation

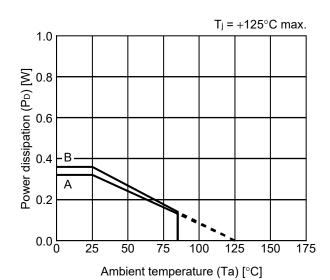
SNT-6A

DFN-6(1414)A



Ambient temperature (Ta) [°C]

| Board | Power Dissipation (P _D) |
|-------|-------------------------------------|
| А | 0.45 W |
| В | 0.57 W |
| С | _ |
| D | _ |
| E | _ |



 Board
 Power Dissipation (PD)

 A
 0.32 W

 B
 0.36 W

 C

 D

 E

SNT-6A Test Board

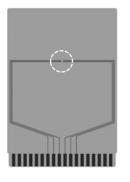
(1) Board A

) IC Mount Area



| Item | | Specification |
|-----------------------------|---|---|
| Size [mm] | | 114.3 x 76.2 x t1.6 |
| Material | | FR-4 |
| Number of copper foil layer | | 2 |
| | 1 | Land pattern and wiring for testing: t0.070 |
| Copper foil layer [mm] | 2 | - |
| | 3 | - |
| | 4 | 74.2 x 74.2 x t0.070 |
| Thermal via | | - |

(2) Board B



| Item | | Specification |
|-----------------------------|---|---|
| Size [mm] | | 114.3 x 76.2 x t1.6 |
| Material | | FR-4 |
| Number of copper foil layer | | 4 |
| | 1 | Land pattern and wiring for testing: t0.070 |
| Copper foil layer [mm] | 2 | 74.2 x 74.2 x t0.035 |
| | 3 | 74.2 x 74.2 x t0.035 |
| | 4 | 74.2 x 74.2 x t0.070 |
| Thermal via | | - |

No. SNT6A-A-Board-SD-1.0

DFN-6(1414)A Test Board

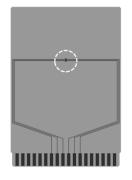
(1) Board A

O IC Mount Area



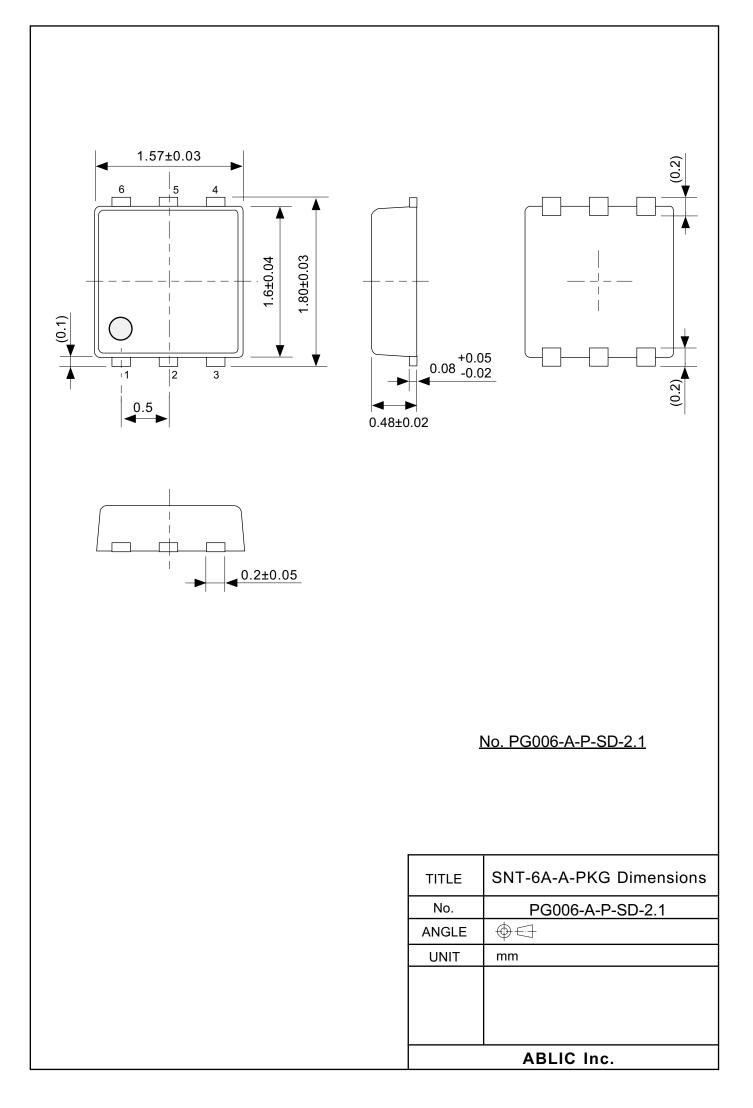
| Item | | Specification | | |
|-----------------------------|---|---|--|--|
| Size [mm] | | 114.3 x 76.2 x t1.6 | | |
| Material | | FR-4 | | |
| Number of copper foil layer | | 2 | | |
| | 1 | Land pattern and wiring for testing: t0.070 | | |
| Copper foil layer [mm] | 2 | - | | |
| | 3 | - | | |
| | 4 | 74.2 x 74.2 x t0.070 | | |
| Thermal via | | - | | |

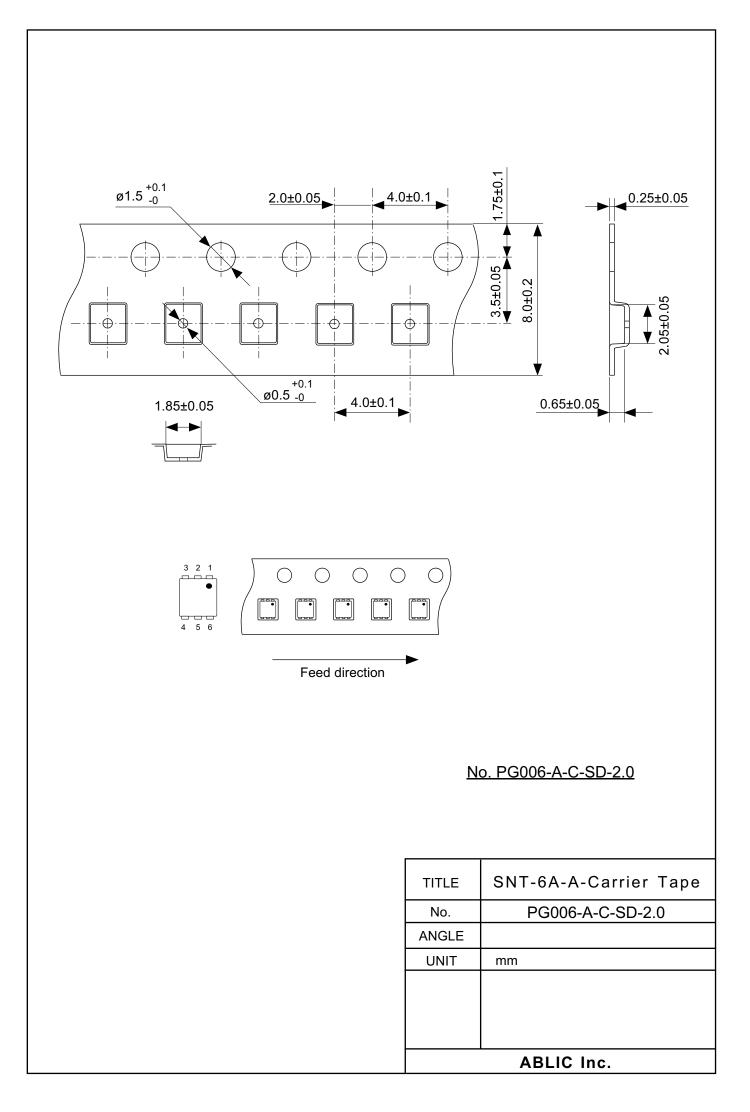
(2) Board B

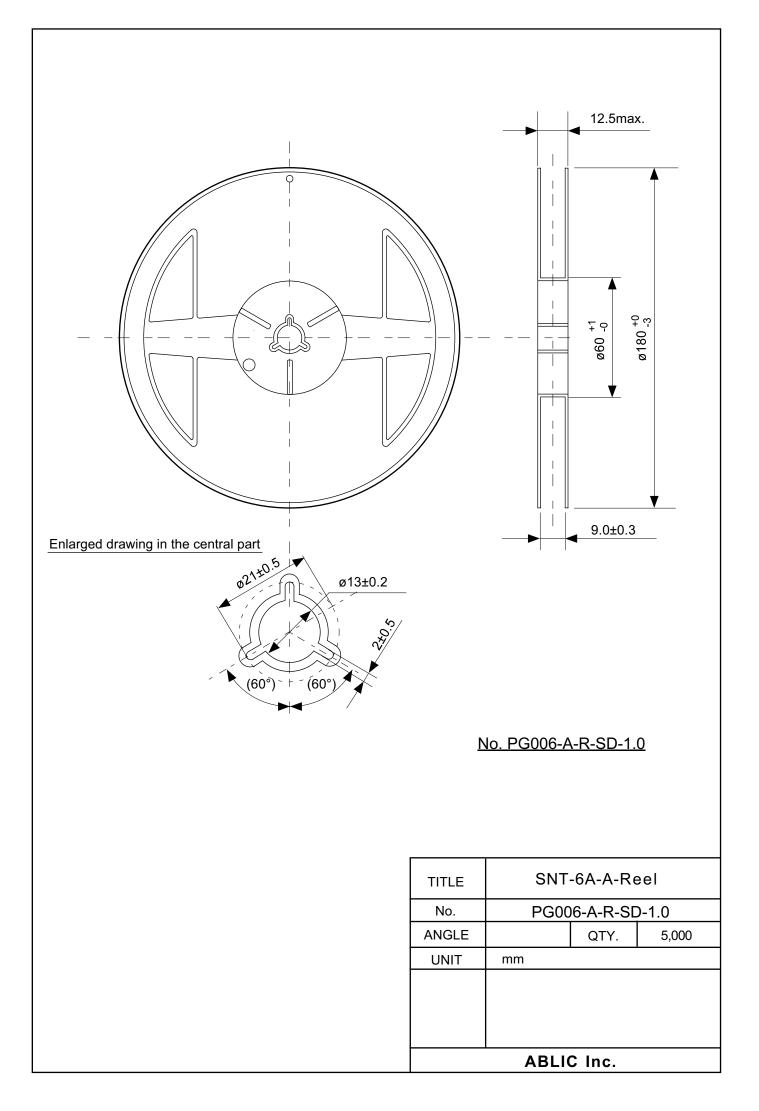


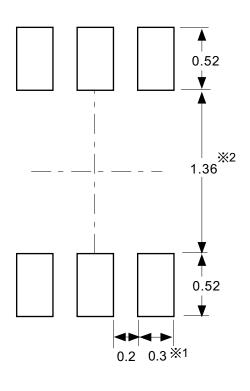
| Item | | Specification |
|-----------------------------|---|---|
| Size [mm] | | 114.3 x 76.2 x t1.6 |
| Material | | FR-4 |
| Number of copper foil layer | | 4 |
| | 1 | Land pattern and wiring for testing: t0.070 |
| Copper foil layer [mm] | 2 | 74.2 x 74.2 x t0.035 |
| Copper foir layer [min] | 3 | 74.2 x 74.2 x t0.035 |
| | 4 | 74.2 x 74.2 x t0.070 |
| Thermal via | | - |

No. DFN6-A-Board-SD-1.0









※1. ランドパターンの幅に注意してください (0.25 mm min. / 0.30 mm typ.)。 ※2. パッケージ中央にランドパターンを広げないでください (1.30 mm ~ 1.40 mm)。

- 注意 1. パッケージのモールド樹脂下にシルク印刷やハンダ印刷などしないでください。
 - 2. パッケージ下の配線上のソルダーレジストなどの厚みをランドパターン表面から0.03 mm 以下にしてください。
 - 3. マスク開ロサイズと開口位置はランドパターンと合わせてください。
 - 4. 詳細は "SNTパッケージ活用の手引き" を参照してください。

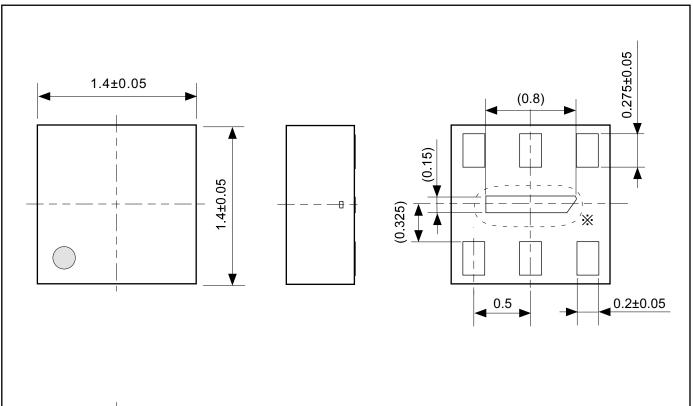
%1. Pay attention to the land pattern width (0.25 mm min. / 0.30 mm typ.).

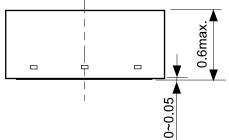
%2. Do not widen the land pattern to the center of the package (1.30 mm ~ 1.40 mm).

- Caution 1. Do not do silkscreen printing and solder printing under the mold resin of the package.
 2. The thickness of the solder resist on the wire pattern under the package should be 0.03 mm or less from the land pattern surface.
 - 3. Match the mask aperture size and aperture position with the land pattern.
 - 4. Refer to "SNT Package User's Guide" for details.
- ※1. 请注意焊盘模式的宽度 (0.25 mm min. / 0.30 mm typ.)。
- ※2. 请勿向封装中间扩展焊盘模式 (1.30 mm~1.40 mm)。
- 注意 1. 请勿在树脂型封装的下面印刷丝网、焊锡。
 - 2. 在封装下、布线上的阻焊膜厚度 (从焊盘模式表面起) 请控制在 0.03 mm 以下。
 - 3. 钢网的开口尺寸和开口位置请与焊盘模式对齐。
 - 4. 详细内容请参阅 "SNT 封装的应用指南"。

| TITLE | SNT-6A-A -Land Recommendation | | | | |
|------------|----------------------------------|--|--|--|--|
| No. | PG006-A-L-SD-4.1 | | | | |
| ANGLE | | | | | |
| UNIT | mm | | | | |
| | | | | | |
| | | | | | |
| | | | | | |
| ABLIC Inc. | | | | | |

No. PG006-A-L-SD-4.1

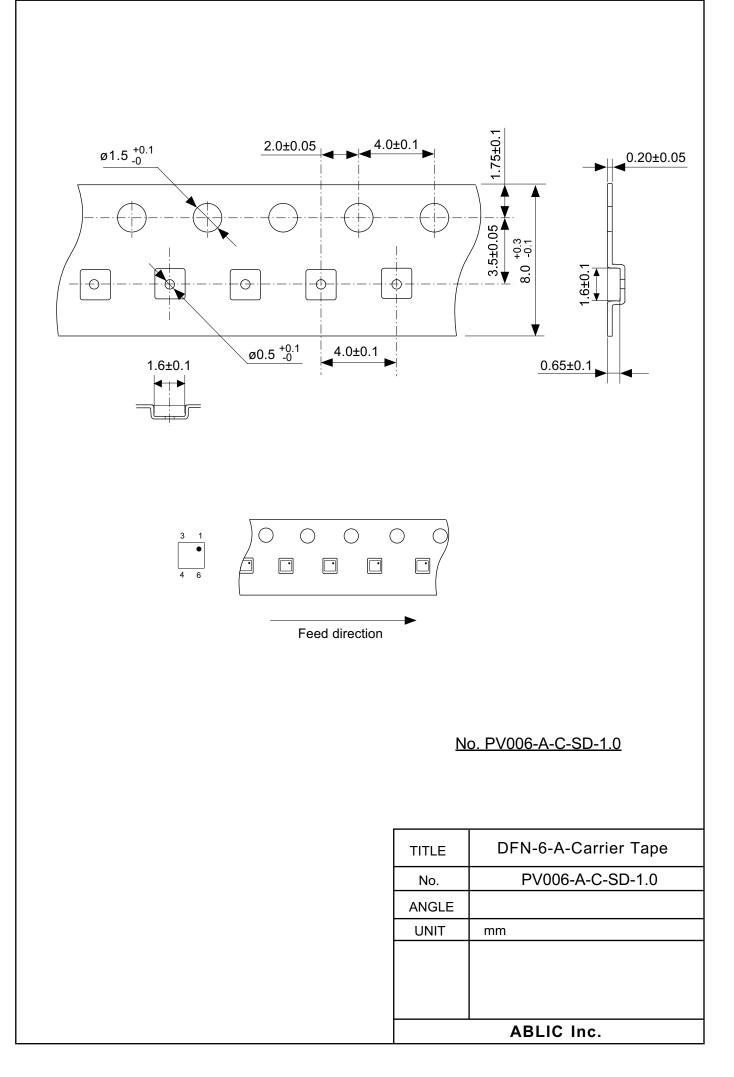


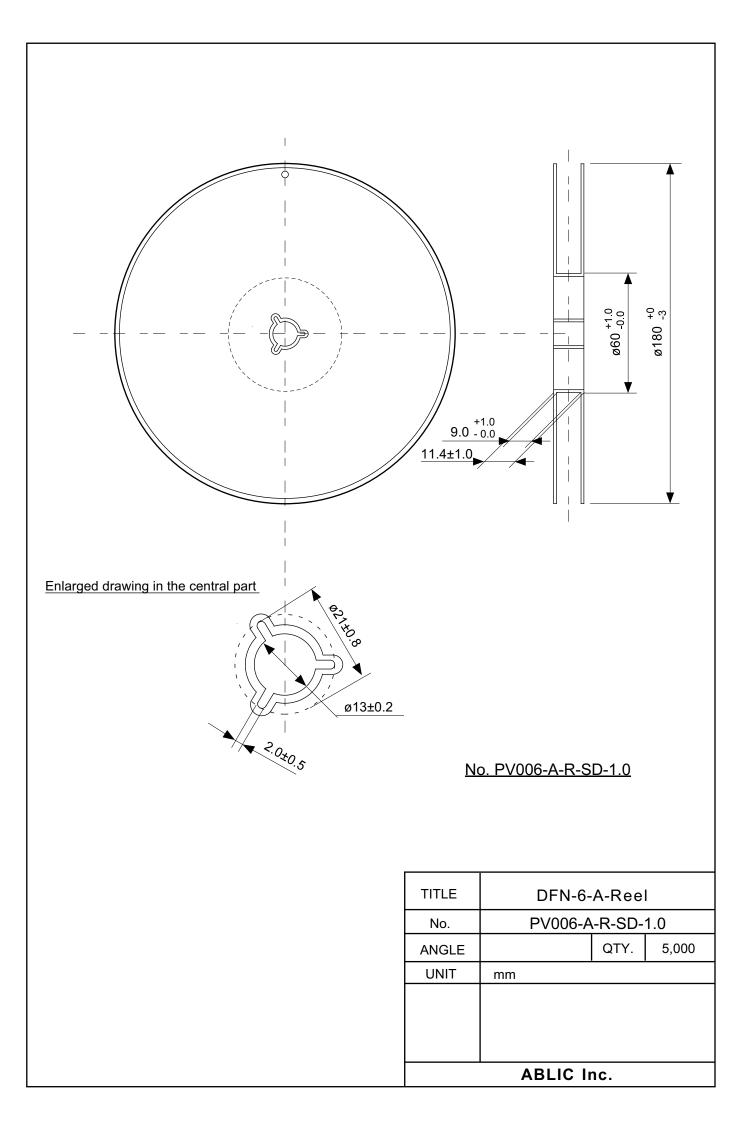


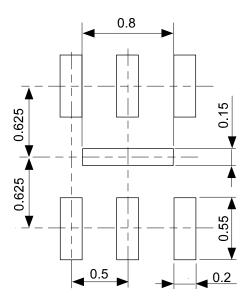
The heat sink of back side has different electric potential depending on the product.
 Confirm specifications of each product.
 Do not use it as the function of electrode.

No. PV006-A-P-SD-2.0

| TITLE | DFN-6-A-PKG Dimensions |
|------------|-------------------------|
| No. | PV006-A-P-SD-2.0 |
| ANGLE | $\bigoplus \in \exists$ |
| UNIT | mm |
| | |
| | |
| | |
| ABLIC Inc. | |







Caution It is recommended to solder the heat sink to a board in order to ensure the heat radiation.

注意 放熱性を確保する為に、PKGの裏面放熱板(ヒートシンク)を基板に 半田付けする事を推奨いたします。

No. PV006-A-L-SD-1.0

| TITLE | DFN-6-A -Land Recommendation |
|------------|---------------------------------|
| No. | PV006-A-L-SD-1.0 |
| ANGLE | |
| UNIT | mm |
| | |
| | |
| | |
| ABLIC Inc. | |

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The entire system in which the products are used must be sufficiently evaluated and judged whether the products are allowed to apply for the system on customer's own responsibility.

- 10. The products are not designed to be radiation-proof. The necessary radiation measures should be taken in the product design by the customer depending on the intended use.
- 11. The products do not affect human health under normal use. However, they contain chemical substances and heavy metals and should therefore not be put in the mouth. The fracture surfaces of wafers and chips may be sharp. Be careful when handling these with the bare hands to prevent injuries, etc.
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2.4-2019.07